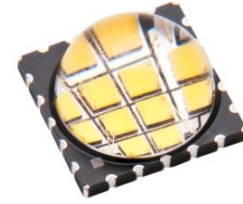


High Luminous Flux Density Cool White LED Emitter **LZC-00CW00**



Key Features

- High Luminous Flux Density 12-die Cool White LED
- More than 40 Watt power dissipation capability
- Small foot print – 9.0mm x 9.0mm
- Industry lowest thermal resistance per package size (0.7°C/W)
- Surface mount ceramic package with integrated glass lens
- Spatial color uniformity across radiation pattern
- Excellent Color Rendering Index
- JEDEC Level 1 for Moisture Sensitivity Level
- Lead (Pb) free and RoHS compliant
- Reflow solderable (up to 6 cycles)
- Emitter available with several MCPCB options
- Full suite of TIR secondary optics family available

Typical Applications

- General lighting
- Down lighting
- Architectural lighting
- Street lighting
- Stage and Studio lighting
- Refrigeration lighting
- Portable lighting

Description

The LZC-series 12-die White LED emitter has an electrical input power dissipation capability of more than 40 Watt electrical power in an extremely small package. With a small 9.0mm x 9.0mm ultra-small footprint, this package provides exceptional luminous flux density. LED Engin's patent-pending thermally insulated phosphor layer provides a spatial color uniformity across the radiation pattern and a consistent CCT over time and temperature. The high quality materials used in the package are chosen to minimize stresses and optimize light output which results in superior reliability and lumen maintenance. The robust product design thrives in outdoor applications with high ambient temperatures and high humidity.

Part number options

Base part number

Part number	Description
LZC-00CW00-xxxx	LZC emitter
LZC-70CW00-xxxx	LZC emitter on 1 channel 1x12 Star MCPCB
LZC-C0CW00-xxxx	LZC emitter on 2 channel 2x6 Star MCPCB
LZC-E0CWT1-xxxx	LZC emitter on 1 channel 1x12 Connectorized MCPCB
LZC-F0CWT1-xxxx	LZC emitter on 1 channel 2x6 Connectorized MCPCB

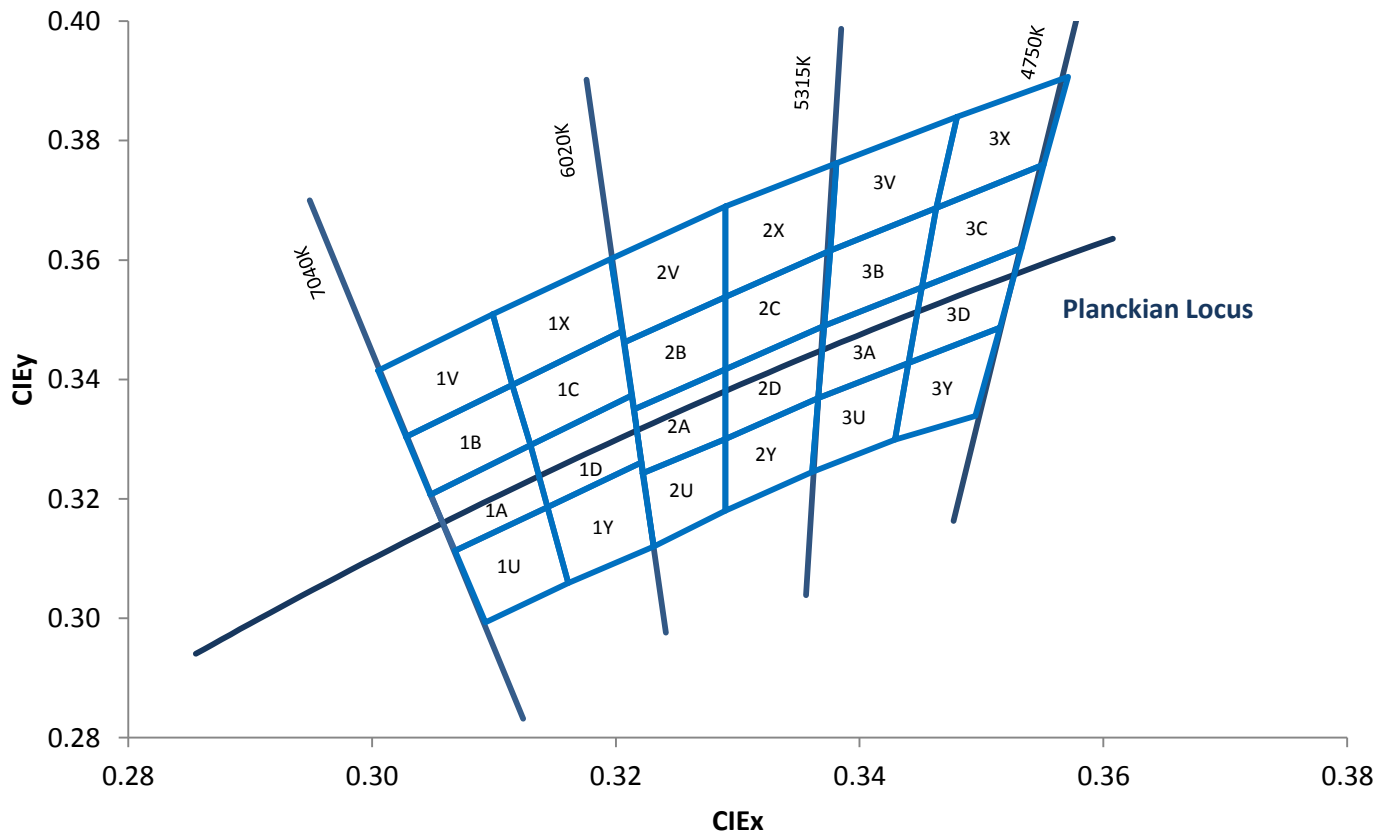
Bin kit option codes

CW, Cool-White (5000K – 6500K)			
Kit number suffix	Min flux Bin	Color Bin Ranges	Description
0000	Z	1U, 1A, 1B, 1V, 1Y, 1D, 1C, 1X, 2U, 2A, 2B, 2V, 2Y, 2D, 2C, 2X, 3U, 3A, 3B, 3V, 3Y, 3D, 3C, 3X	full distribution flux; full distribution CCT
C000	C2	1U, 1A, 1B, 1V, 1Y, 1D, 1C, 1X, 2U, 2A, 2B, 2V, 2Y, 2D, 2C, 2X, 3U, 3A, 3B, 3V, 3Y, 3D, 3C, 3X	C2 minimum flux bin; full distribution CCT
0050	Z	2Y, 2D, 2C, 2X, 3U, 3A, 3B, 3V, 3Y, 3D, 3C, 3X	full distribution flux; 5000K ANSI CCT bin
C050	C2	2Y, 2D, 2C, 2X, 3U, 3A, 3B, 3V, 3Y, 3D, 3C, 3X	C2 minimum flux bin; 5000K ANSI CCT bin
0055	Z	2U, 2Y, 3U, 2A, 2D, 3A, 2B, 2C, 3B, 2V, 2X, 3V	full distribution flux; 5500K ANSI CCT bin
C055	C2	2U, 2Y, 3U, 2A, 2D, 3A, 2B, 2C, 3B, 2V, 2X, 3V	C2 minimum flux bin; 5500K ANSI CCT bin
0056	Z	1Y, 1D, 1C, 1X, 2U, 2A, 2B, 2V, 2Y, 2D, 2C, 2X	full distribution flux; 5600K ANSI CCT bin
C056	C2	1Y, 1D, 1C, 1X, 2U, 2A, 2B, 2V, 2Y, 2D, 2C, 2X	C2 minimum flux bin; 5600K ANSI CCT bin
0065	Z	1U, 1A, 1B, 1V, 1Y, 1D, 1C, 1X, 2U, 2A, 2B, 2V	full distribution flux; 6500K ANSI CCT bin
C065	C2	1U, 1A, 1B, 1V, 1Y, 1D, 1C, 1X, 2U, 2A, 2B, 2V	C2 minimum flux bin; 6500K ANSI CCT bin

Notes:

1. Default bin kit option is -0000

Cool White Chromaticity Groups



Standard Chromaticity Groups plotted on excerpt from the CIE 1931 (2°) x-y Chromaticity Diagram.
Coordinates are listed below in the table.

Cool White Bin Coordinates

Bin code	CIE _x	CIE _y	Bin code	CIE _x	CIE _y	Bin code	CIE _x	CIE _y	Bin code	CIE _x	CIE _y
1U	0.3068	0.3113	1A	0.3048	0.3207	1B	0.3028	0.3304	1V	0.3005	0.3415
	0.3144	0.3186		0.313	0.329		0.3115	0.3391		0.3099	0.3509
	0.3161	0.3059		0.3144	0.3186		0.313	0.329		0.3115	0.3391
	0.3093	0.2993		0.3068	0.3113		0.3048	0.3207		0.3028	0.3304
1Y	0.3068	0.3113	1D	0.3048	0.3207	1C	0.3028	0.3304	1X	0.3005	0.3415
	0.3144	0.3186		0.313	0.329		0.3115	0.3391		0.3099	0.3509
	0.3221	0.3261		0.3213	0.3373		0.3205	0.3481		0.3196	0.3602
	0.3231	0.312		0.3221	0.3261		0.3213	0.3373		0.3205	0.3481
2U	0.3161	0.3059	2A	0.3144	0.3186	2B	0.313	0.329	2V	0.3115	0.3391
	0.3144	0.3186		0.313	0.329		0.3115	0.3391		0.3099	0.3509
	0.3222	0.3243		0.3215	0.335		0.3207	0.3462		0.3196	0.3602
	0.329	0.33		0.329	0.3417		0.329	0.3538		0.329	0.369
2Y	0.329	0.318	2D	0.329	0.33	2C	0.329	0.3417	2X	0.329	0.3538
	0.3231	0.312		0.3222	0.3243		0.3215	0.335		0.3207	0.3462
	0.3222	0.3243		0.3215	0.335		0.3207	0.3462		0.3196	0.3602
	0.329	0.33		0.329	0.3417		0.329	0.3538		0.329	0.369
3U	0.3366	0.3369	3A	0.3371	0.349	3B	0.3376	0.3616	3V	0.3381	0.3762
	0.344	0.3428		0.3451	0.3554		0.3463	0.3687		0.348	0.384
	0.3429	0.3299		0.344	0.3427		0.3451	0.3554		0.3463	0.3687
	0.3361	0.3245		0.3366	0.3369		0.3371	0.349		0.3376	0.3616
3Y	0.3366	0.3369	3D	0.3371	0.349	3C	0.3376	0.3616	3X	0.3381	0.3762
	0.344	0.3428		0.3451	0.3554		0.3463	0.3687		0.348	0.384
	0.3515	0.3487		0.3533	0.362		0.3551	0.376		0.3571	0.3907
	0.3495	0.3339		0.3515	0.3487		0.3533	0.362		0.3551	0.376
	0.3429	0.3299		0.344	0.3427		0.3451	0.3554		0.3463	0.3687
	0.344	0.3428		0.3451	0.3554		0.3463	0.3687		0.348	0.384

Luminous Flux Bins

Table 1:

Bin Code	Minimum Luminous Flux (Φ_v) @ $I_F = 700\text{mA}$ ^[1,2] (lm)	Maximum Luminous Flux (Φ_v) @ $I_F = 700\text{mA}$ ^[1,2] (lm)	Typical Luminous Flux (Φ_v) @ $I_F = 1000\text{mA}$ ^[2] (lm)
Z	1,696	2,120	2,400
C2	2,120	2,350	3,000

Notes for Table 1:

1. Luminous flux performance guaranteed within published operating conditions. LED Engin maintains a tolerance of $\pm 10\%$ on flux measurements.
2. Luminous Flux typical value is for all 12 LED dice operating concurrently at rated current.

Forward Voltage Bins

Table 2:

Bin Code	Minimum Forward Voltage (V_F) @ $I_F = 700\text{mA}$ ^[1,2] (V)	Maximum Forward Voltage (V_F) @ $I_F = 700\text{mA}$ ^[1,2] (V)
0	38.40	47.04

Notes for Table 2:

1. LED Engin maintains a tolerance of $\pm 0.48\text{V}$ for forward voltage measurements.
2. Forward Voltage is binned with 12 LED dice connected in series. The actual LED is configured with two strings of 6 dice in series.

Absolute Maximum Ratings

Table 3:

Parameter	Symbol	Value	Unit
DC Forward Current at $T_{jmax}=130^{\circ}C$ ^[1]	I_F	1200	mA
DC Forward Current at $T_{jmax}=150^{\circ}C$ ^[1]	I_F	1000	mA
Peak Pulsed Forward Current ^[2]	I_{FP}	1500	mA
Reverse Voltage	V_R	See Note 3	V
Storage Temperature	T_{stg}	-40 ~ +150	$^{\circ}C$
Junction Temperature	T_J	150	$^{\circ}C$
Soldering Temperature ^[4]	T_{sol}	260	$^{\circ}C$
Allowable Reflow Cycles		6	
ESD Sensitivity ^[5]		> 8,000 V HBM Class 3B JESD22-A114-D	

Notes for Table 3:

- Maximum DC forward current (per die) is determined by the overall thermal resistance and ambient temperature. Follow the curves in Figure 10 for current derating.
- Pulse forward current conditions: Pulse Width $\leq 10\text{msec}$ and Duty cycle $\leq 10\%$.
- LEDs are not designed to be reverse biased.
- Solder conditions per JEDEC 020D. See Reflow Soldering Profile Figure 5.
- LED Engin recommends taking reasonable precautions towards possible ESD damages and handling the LZ4-00CW40 in an electrostatic protected area (EPA). An EPA may be adequately protected by ESD controls as outlined in ANSI/ESD S6.1.

Optical Characteristics @ $T_c = 25^{\circ}C$

Table 4:

Parameter	Symbol	Typical	Unit
Luminous Flux (@ $I_F = 700\text{mA}$) ^[1]	Φ_V	2100	lm
Luminous Flux (@ $I_F = 1000\text{mA}$) ^[1]	Φ_V	2700	lm
Luminous Efficacy (@ $I_F = 350\text{mA}$)		90	lm/W
Correlated Color Temperature	CCT	5500	K
Color Rendering Index (CRI)	R_a	>70	
Viewing Angle ^[2]	$2\Theta_{1/2}$	110	Degrees

Notes for Table 4:

- Luminous flux typical value is for all 12 LED dice operating concurrently at rated current.
- Viewing Angle is the off-axis angle from emitter centerline where the luminous intensity is $\frac{1}{2}$ of the peak value.

Electrical Characteristics @ $T_c = 25^{\circ}C$

Table 5:

Parameter	Symbol	Typical	Unit
Forward Voltage (@ $I_F = 700\text{mA}$) ^[1]	V_F	42.0	V
Forward Voltage (@ $I_F = 1000\text{mA}$) ^[1]	V_F	43.8	V
Temperature Coefficient of Forward Voltage ^[1]	$\Delta V_F / \Delta T_J$	-33.6	mV/ $^{\circ}C$
Thermal Resistance (Junction to Case)	$R\Theta_{J-C}$	0.7	$^{\circ}C/W$

Notes for Table 5:

- Forward Voltage is binned with 12 LED dice connected in series. The actual LED is configured with two strings of 6 dice in series.

IPC/JEDEC Moisture Sensitivity Level

Table 6 - IPC/JEDEC J-STD-20.1 MSL Classification:

Level	Floor Life		Soak Requirements			
	Time	Conditions	Standard	Conditions	Accelerated	Conditions
1	unlimited	$\leq 30^{\circ}\text{C}/$ 85% RH	168 +5/-0	$85^{\circ}\text{C}/$ 85% RH	n/a	n/a

Notes for Table 6:

1. The standard soak time includes a default value of 24 hours for semiconductor manufacturer's exposure time (MET) between bake and bag and includes the maximum time allowed out of the bag at the distributor's facility.

Average Lumen Maintenance Projections

Lumen maintenance generally describes the ability of a lamp to retain its output over time. The useful lifetime for solid state lighting devices (Power LEDs) is also defined as Lumen Maintenance, with the percentage of the original light output remaining at a defined time period.

Based on long-term WHTOL testing, LED Engin projects that the LZ Series will deliver, on average, 70% Lumen Maintenance at 65,000 hours of operation at a forward current of 700 mA per die. This projection is based on constant current operation with junction temperature maintained at or below 125°C.

Mechanical Dimensions (mm)

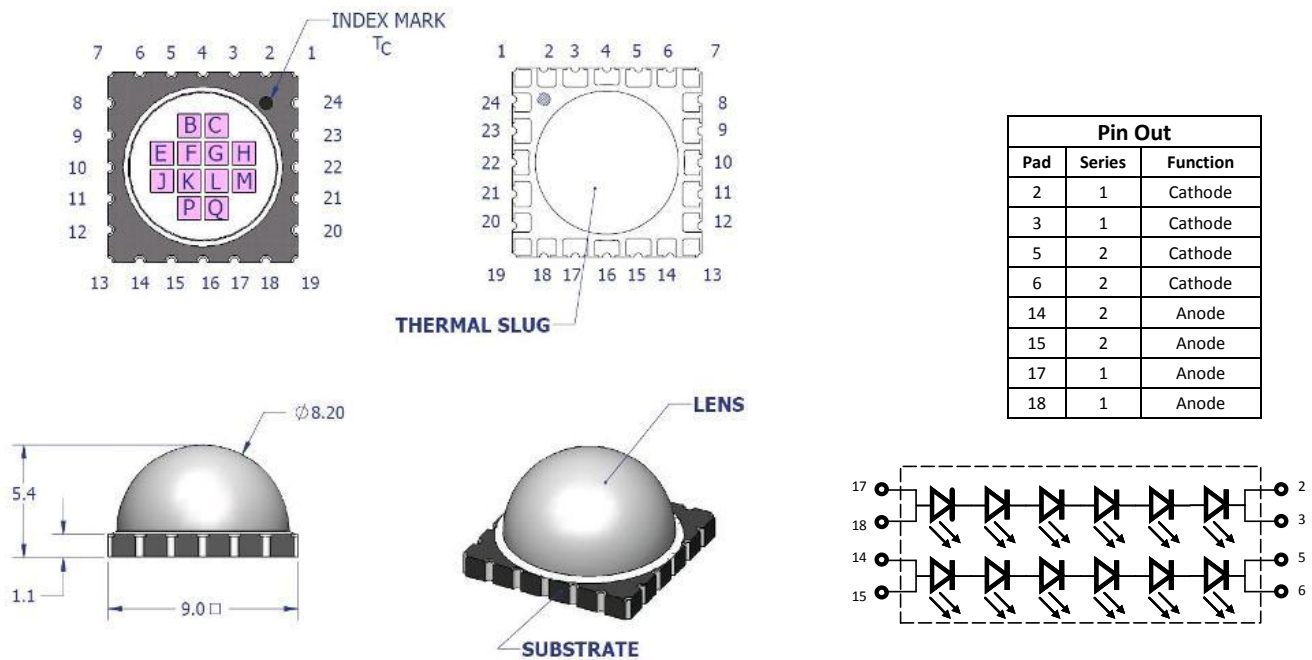


Figure 1: Package outline drawing.

Notes for Figure 1:

1. Unless otherwise noted, the tolerance = ± 0.20 mm.
2. Thermal contact, Pad is electrically neutral.

Recommended Solder Pad Layout (mm)

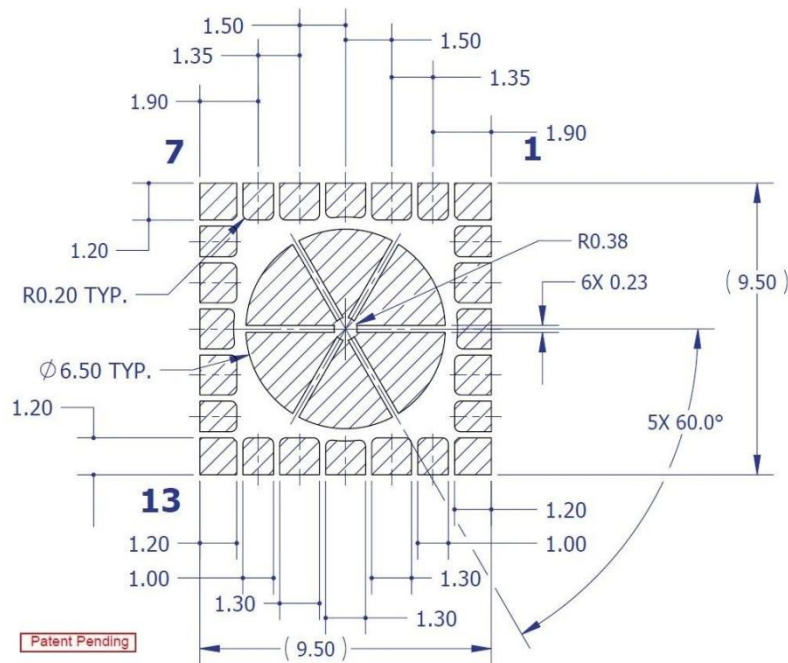


Figure 2a: Recommended solder pad layout for anode, cathode, and thermal pad.

Note for Figure 2a:

1. Unless otherwise noted, the tolerance = ± 0.20 mm.

Typical Radiation Pattern

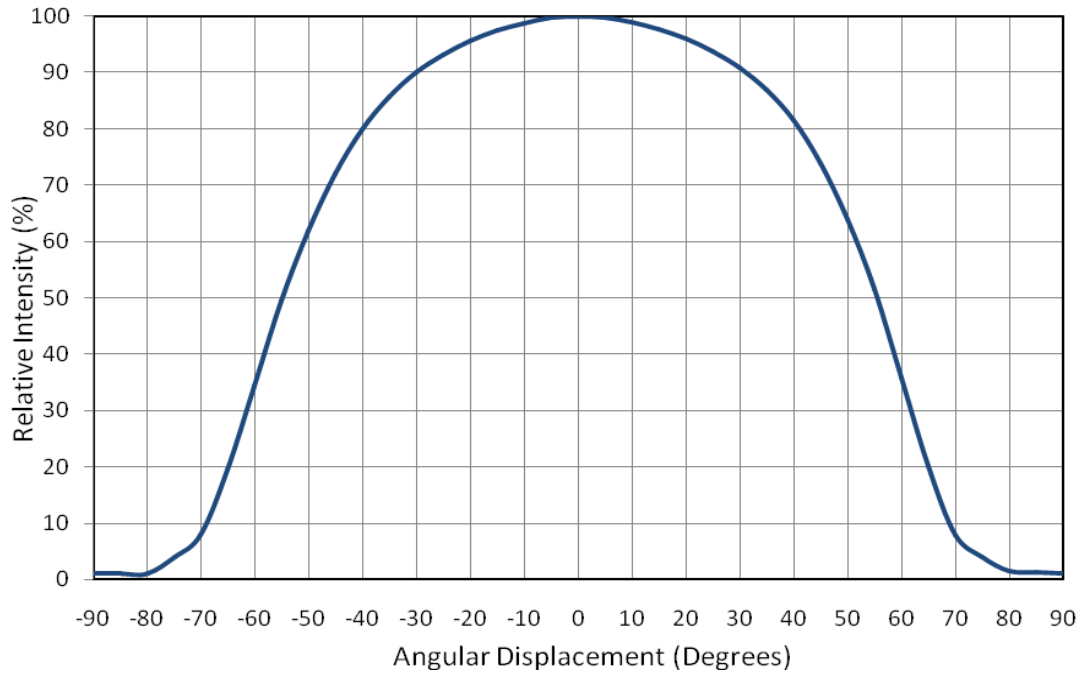


Figure 4: Typical representative spatial radiation pattern.

Typical Relative Spectral Power Distribution

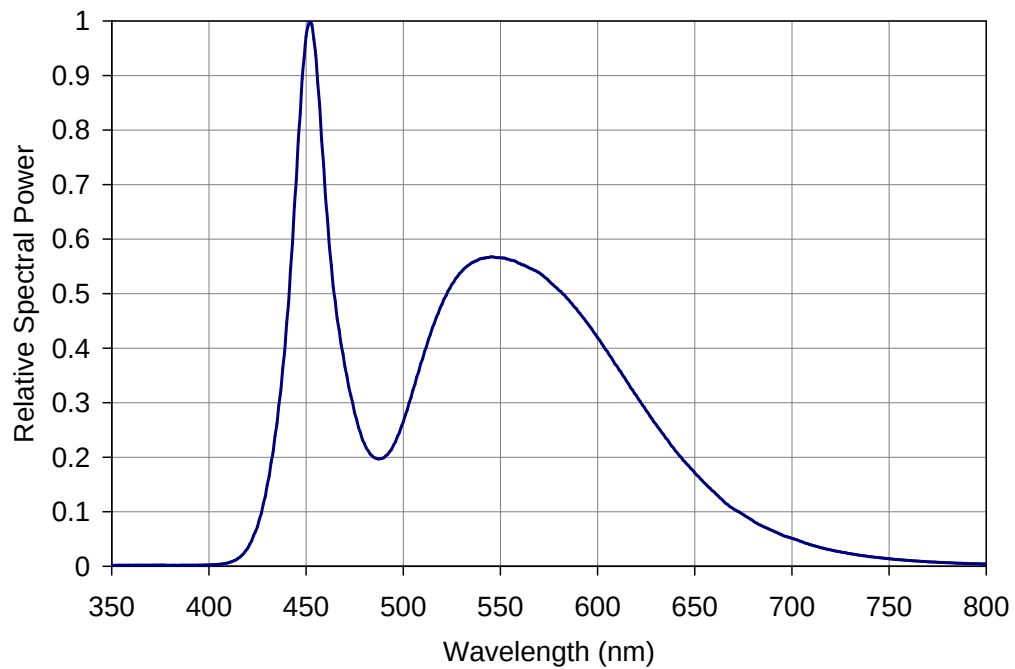


Figure 5: Typical relative spectral power vs. wavelength @ T_c = 25°C.

Typical Relative Light Output

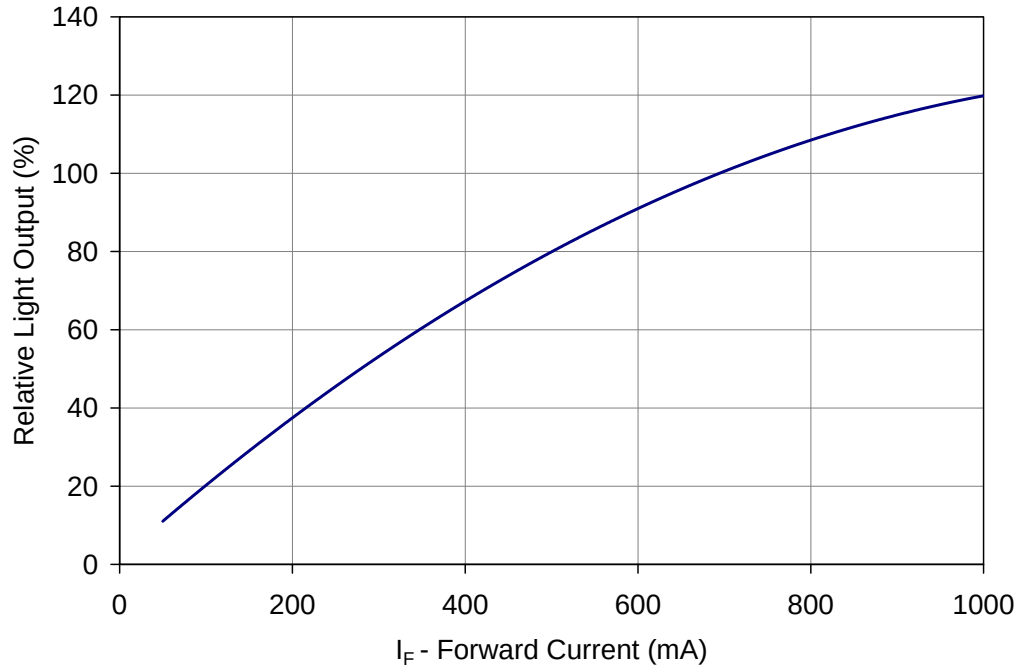


Figure 6: Typical relative light output vs. forward current @ T_C = 25°C.

Notes for Figure 6:

1. Luminous Flux typical value is for all 12 LED dice operating concurrently at rated current.

Typical Relative Light Output over Temperature

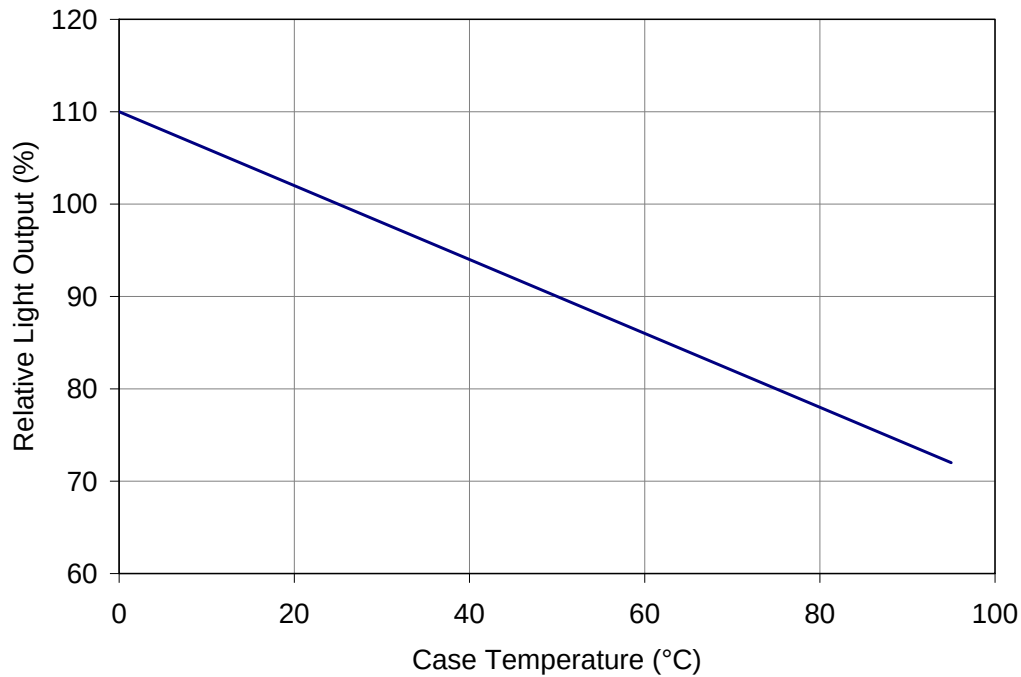


Figure 7: Typical relative light output vs. case temperature.

Notes for Figure 7:

1. Luminous Flux typical value is for all 12 LED dice operating concurrently at rated current.

Typical Forward Current Characteristics

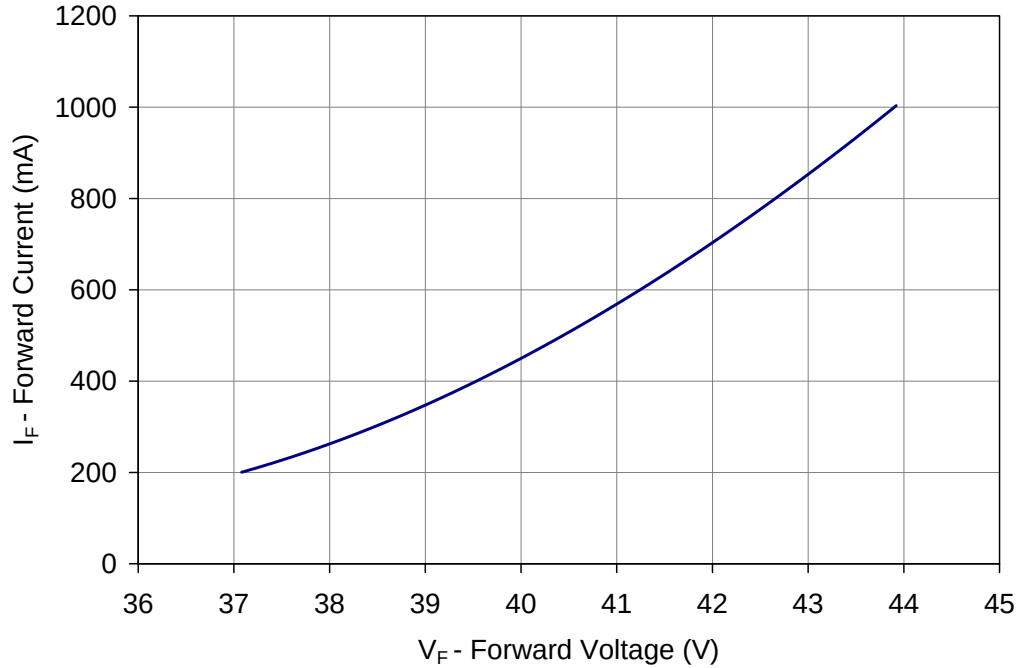


Figure 8: Typical forward current vs. forward voltage @ $T_C = 25^\circ\text{C}$.

Note for Figure 8:

1. Forward Voltage assumes 12 LED dice connected in series. The actual LED is configured with two strings of 6 dice in series.

Current De-rating

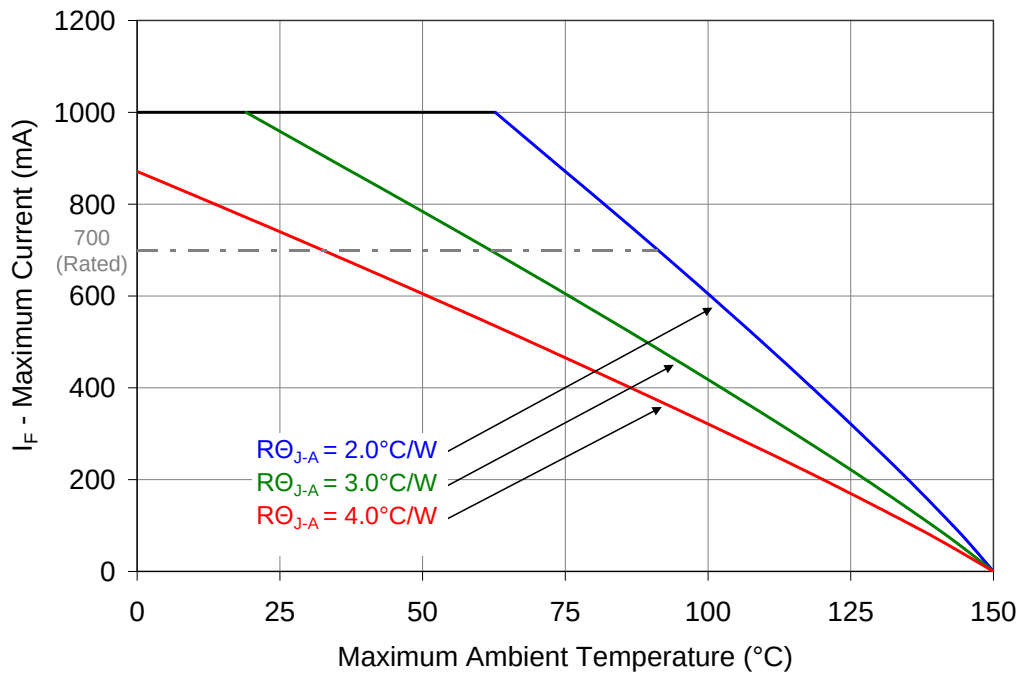


Figure 9: Maximum forward current vs. ambient temperature based on $T_{J(MAX)} = 150^\circ\text{C}$.

Notes for Figure 9:

1. Maximum current assumes that all LED dice are operating concurrently at the same current.
2. RO_{J-C} [Junction to Case Thermal Resistance] for the LZC-00xx00 is typically 0.7°C/W .
3. RO_{J-A} [Junction to Ambient Thermal Resistance] = $RO_{J-C} + RO_{C-A}$ [Case to Ambient Thermal Resistance].

Emitter Tape and Reel Specifications (mm)

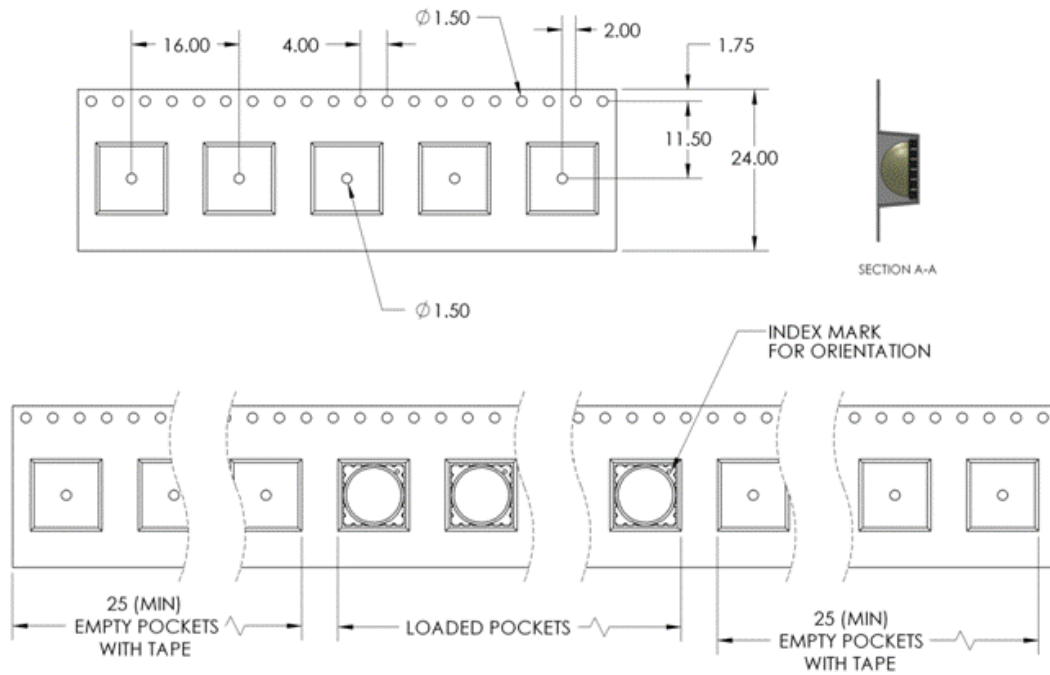


Figure 10: Emitter carrier tape specifications (mm).

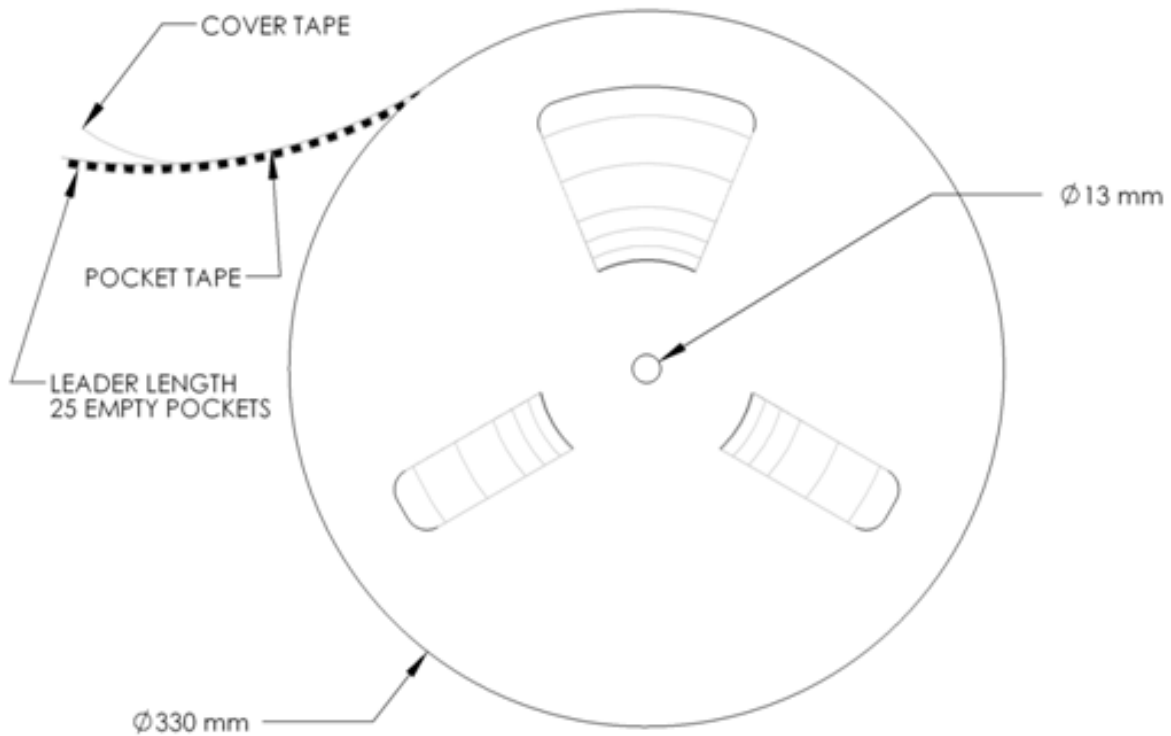


Figure 11: Emitter Reel specifications (mm).

LZC MCPCB Family

Part number	Type of MCPCB	Diameter (mm)	Emitter + MCPCB Thermal Resistance (°C/W)	Typical V_f (V)	Typical I_f (mA)
LZC-7xxxxx	1-channel	28.3	$0.7 + 0.6 = 1.3$	42.0	700
LZC-Cxxxxx	2-channel	28.3	$0.7 + 0.6 = 1.3$	21.0	2 x 700
LZC-ExxxT1	1-channel (1 x 12 string)	49.5	$0.7 + 0.6 = 1.3$	42.0	700
LZC-FxxxT1	1-channel (2 x 6 strings)	49.5	$0.7 + 0.6 = 1.3$	21.0	1400

Mechanical Mounting of MCPCB

- MCPCB bending should be avoided as it will cause mechanical stress on the emitter, which could lead to substrate cracking and subsequently LED dies cracking.
- To avoid MCPCB bending:
 - Special attention needs to be paid to the flatness of the heat sink surface and the torque on the screws.
 - Care must be taken when securing the board to the heat sink. This can be done by tightening three M3 screws (or #4-40) in steps and not all the way through at once. Using fewer than three screws will increase the likelihood of board bending.
 - It is recommended to always use plastics washers in combinations with the three screws.
 - If non-taped holes are used with self-tapping screws, it is advised to back out the screws slightly after tightening (with controlled torque) and then re-tighten the screws again.

Thermal interface material

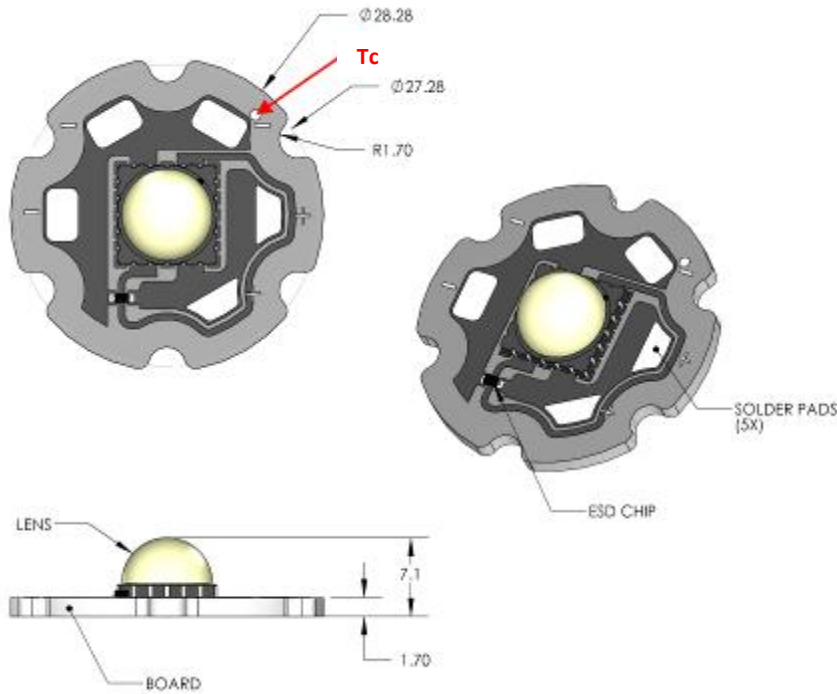
- To properly transfer heat from LED emitter to heat sink, a thermally conductive material is required when mounting the MCPCB on to the heat sink.
- There are several varieties of such material: thermal paste, thermal pads, phase change materials and thermal epoxies. An example of such material is Electrolube EHTC.
- It is critical to verify the material's thermal resistance to be sufficient for the selected emitter and its operating conditions.

Wire soldering

- To ease soldering wire to MCPCB process, it is advised to preheat the MCPCB on a hot plate of 125-150°C. Subsequently, apply the solder and additional heat from the solder iron will initiate a good solder reflow. It is recommended to use a solder iron of more than 60W.
- It is advised to use lead-free, no-clean solder. For example: SN-96.5 AG-3.0 CU 0.5 #58/275 from Kester (pn: 24-7068-7601)

LZC-7xxxxx

1 channel, Star MCPCB (1x12) Dimensions (mm)



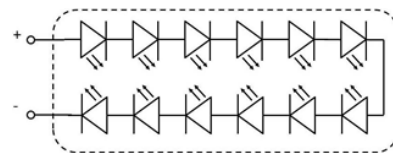
Notes:

- Unless otherwise noted, the tolerance = ± 0.2 mm.
- Slots in MCPCB are for M3 or #4-40 mounting screws.
- LED Engin recommends plastic washers to electrically insulate screws from solder pads and electrical traces.
- Electrical connection pads on MCPCB are labeled "+" for Anode and "-" for Cathode.
- LED Engin recommends using thermal interface material when attaching the MCPCB to a heatsink.
- The thermal resistance of the MCPCB is: R θ C-B 0.6°C/W

Components used

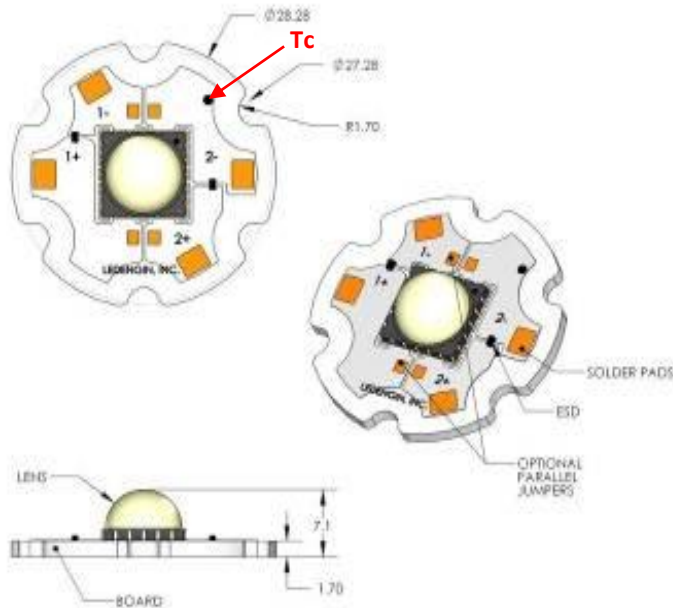
MCPCB: HT04503 (Bergquist)
ESD chips: BZX585-C51 (NXP, for 12 LED dies in series)

Pad layout			
Ch.	MCPCB Pad	String/die	Function
1	+	1/BCEFGHJ	Anode +
	-	KLMPQ	Cathode -



LZC-Cxxxxx

2 channel, Star MCPCB (2x6) Dimensions (mm)



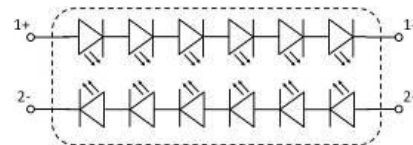
Notes:

- Unless otherwise noted, the tolerance = ± 0.2 mm.
- Slots in MCPCB are for M3 or #4-40 mounting screws.
- LED Engin recommends plastic washers to electrically insulate screws from solder pads and electrical traces.
- Electrical connection pads on MCPCB are labeled "+" for Anode and "-" for Cathode.
- LED Engin recommends thermal interface material when attaching the MCPCB to a heatsink.
- The thermal resistance of the MCPCB is: $R_{\theta C-B}$ 0.6°C/W

Components used

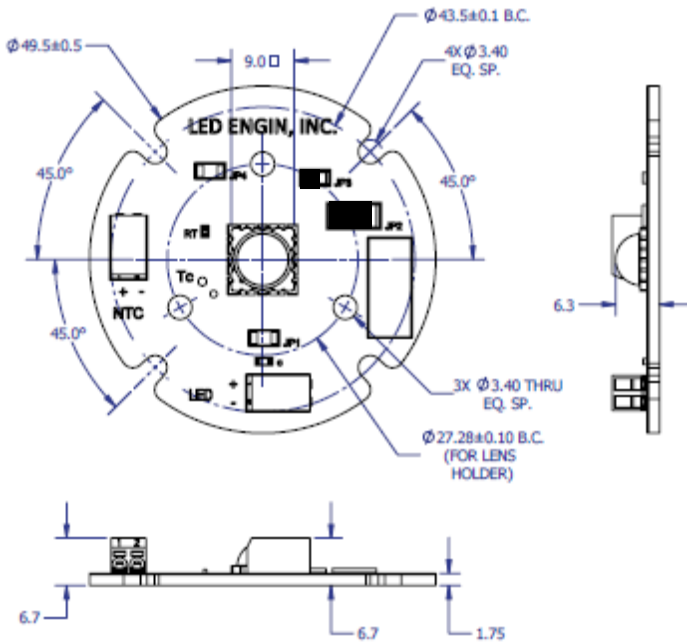
MCPCB: HT04503 (Bergquist)
ESD chips: BZT52C36LP-36 (Diodes, Inc, for 6 LED dies in series)

Pad layout			
Ch.	MCPCB Pad	String/die	Function
1	+	1/BCEFGHJ	Anode +
	-	KLMPQ	Cathode -



LZC-ExxxT1

1 channel, Connectorized MCPCB with Thermistor (1x12) Dimensions (mm)



Note for Figure 1:

- Unless otherwise noted, the tolerance = ± 0.2 mm. angle = $\pm 1^\circ$
- Slots in MCPCB are for M3 or #4-40 mounting screws. Maximum torque should not exceed 1N-m (8.9 lbf-in)
- LED Engin recommends plastic washers to electrically insulate screws from solder pads and electrical traces.
- LED Engin recommends using thermally interface material when attaching the MCPCB to a heatsink
- For the connectors it is recommended to use solid wires with gauge size, 18, 20 or 22 AWG. It is recommended to strip the insulation of the wires to a length of 4-5mm. When stranded wires are used it is recommended to twists the strands at the end of the wire and use wire extraction toll to insert the wires.
- The thermal resistance of the MCPCB is: $R_{\theta C-B}$ 0.6°C/W

Components used

MCPCB: HT04503

ESD chips: BZX585-C51

Thermistor: NCP15WF104F03RC

(Bergquist)

(NXP, for 12 LED dies in series)

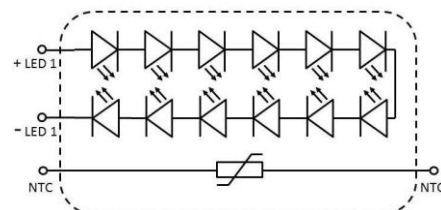
(Murata, 100kOhm for the LZx-xxxxT1, please see

www.murata.com for details on calculating the thermistor temperature)

Connectors: 00-9276-002-0-21-1-06

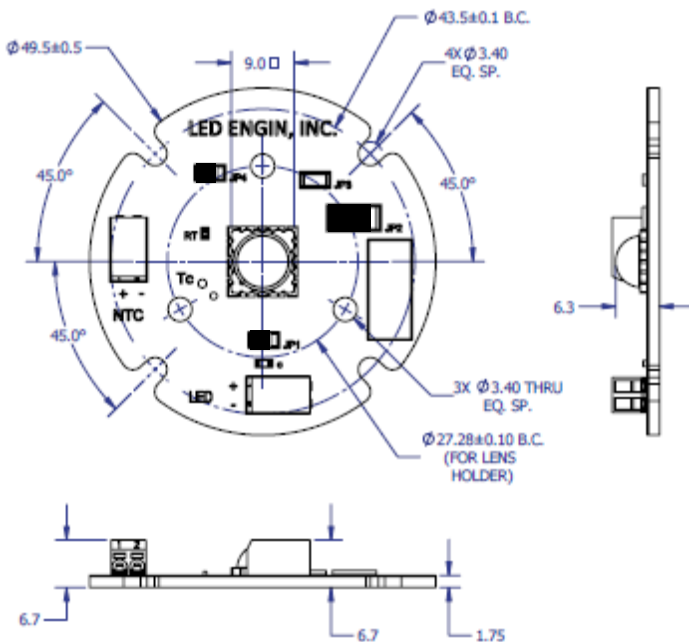
(AVX, poke-home)

Ch.	Pad	Emitter pin	Function
1	LED1+	14, 15	Anode
	LED1-	2, 3	Cathode
T	NTC	na	Anode
	NTC	na	Cathode



LZC-FxxxT1

1 channel, Connectorized MCPCB with Thermistor (2x6) Dimensions (mm)



Note for Figure 1:

- Unless otherwise noted, the tolerance = ± 0.2 mm, angle = $\pm 1^\circ$
- Slots in MCPCB are for M3 or #4-40 mounting screws. Maximum torque should not exceed 1N-m (8.9 lbf-in)
- LED Engin recommends plastic washers to electrically insulate screws from solder pads and electrical traces.
- LED Engin recommends using thermally interface material when attaching the MCPCB to a heatsink
- For the connectors it is recommended to use solid wires with gauge size, 18, 20 or 22 AWG. It is recommended to strip the insulation of the wires to a length of 4-5mm. When stranded wires are used it is recommended to twist the strands at the end of the wire and use wire extraction tool to insert the wires.
- The thermal resistance of the MCPCB is: R0C-B 0.6°C/W

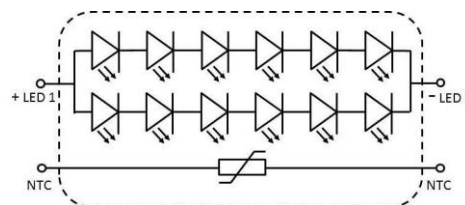
Components used

MCPCB: HT04503
ESD chips: BZT52C36LP
Thermistor: NCP15WF104F03RC

(Bergquist)
(NXP, for 6 LED dies in series)
(Murata, 100kOhm for the LZx-xxxxT1, please see www.murata.com for details on calculating the thermistor temperature)
(AVX, poke-home)

Connectors: 00-9276-002-0-21-1-06

Ch.	Pad	Emitter pin	Function
1	LED1+	14, 15, 17, 18	Anode
	LED1-	2, 3, 5, 6	Cathode
T	NTC	na	Anode
	NTC	na	Cathode

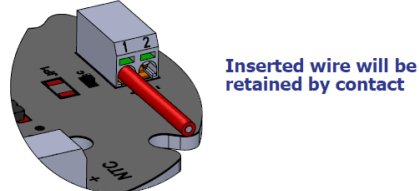
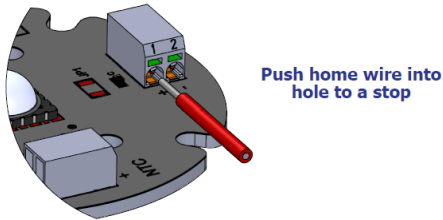


Appendix: Wire Insertion and Extraction Instructions AVX poke-home

For the AVX poke-home it is recommended to use solid wires with gauge size, 18, 20 or 22 AWG, but stranded wire can be used as well. Push the wire in and then give slight tug on the wire to confirm that it is properly engaged.

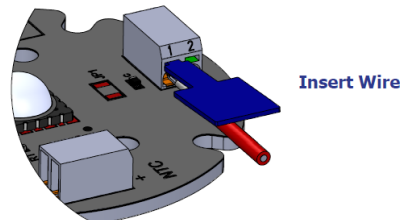
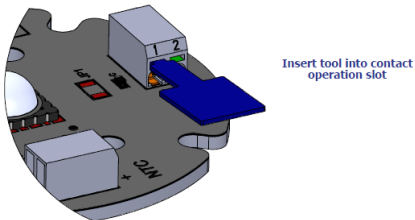
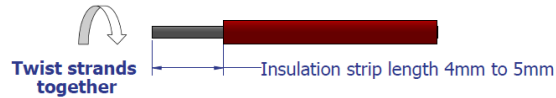
Wire Insertion Solid conductor

- Strip insulation length 4-5mm
- Insert into appropriate hole to a stop
- Inserted wire will be retained by contact



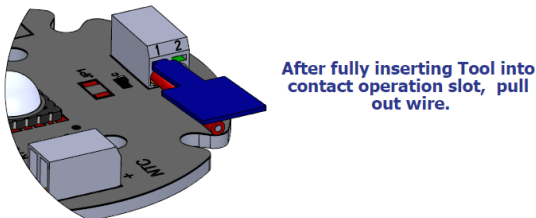
Wire Insertion Stranded wire conductor

- Twist strands together
- Insert tool into contact operation slot
- Insert wire
- Remove tool



Wire extraction

- Insert tool into contact
- Extract wire
- Remove tool



Extraction Tool References:

Thin Blade Wire Extraction Tool: AVX P/N - 0692-7670-0101-000

Miniature Precision Screw Driver, 0.047" Tip Width

Company Information

LED Engin, based in California's Silicon Valley, develops, manufactures, and sells advanced LED emitters, optics and light engines to create uncompromised lighting experiences for a wide range of entertainment, architectural, general lighting and specialty applications. LuxiGen™ multi-die emitter and secondary lens combinations reliably deliver industry-leading flux density, upwards of 5000 quality lumens to a target, in a wide spectrum of colors including whites, tunable whites, multi-color and UV LEDs in a unique patented compact ceramic package. Our LuxiTune™ series of tunable white lighting modules leverage our LuxiGen emitters and lenses to deliver quality, control, freedom and high density tunable white light solutions for a broad range of new recessed and downlighting applications. The small size, yet remarkably powerful beam output and superior in-source color mixing, allows for a previously unobtainable freedom of design wherever high-flux density, directional light is required.

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